

Trench Schottky Rectifier

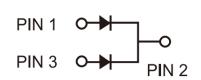
FEATURES

- Patented Trench Schottky technology
- Excellent high temperature stability
- Low forward voltage
- Lower power loss/ High efficiency
- High forward surge capability
- Compliant to RoHS directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition











MECHANICAL DATA

Case: ITO-220AB

Molding compound meets UL 94 V-0 flammability rating Base P/N with suffix "M" on P/N - commercial grade Base P/N with suffix "G" on packing code - green compound (halogen-free) **Terminal:** Matte tin plated leads, solderable per JESD22-B102 Meet JESD 201 class 1A whisker test **Polarity:** As marked

Mounting torque: 0.56 Nm max. **Weight:** 1.7g (approximately)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (TA=25°C unless otherwise noted)							
PARAMETER		SYMBOL	SYMBOL TSF30U60C			UNIT	
Maximum repetitive peak reverse voltage	V _{RRM}	60			V		
Maximum average forward rectified current	per device		30 15			— A	
	per diode	I _{F(AV)}					
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load per diode		I _{FSM}	250		A		
Peak repetitive reverse surge current (Note 1)		I _{RRM}	3		А		
Isolation voltage from terminal to heatsink t = 1 min		V _{AC}	2000		V		
			MIN.	TYP.	MAX.		
Breakdown voltage(I _R =1.0mA, Ta =25°C)		V _{BR}	60	-	-	V	
Maximum instantaneous forward voltage per diode (Note 2)	I _F = 15A T _J = 25°C	V _F	-		0.57	- v	
	I _F = 15A T _J = 125°C	V _F	-	0.53	0.55		
Maximum instantaneous reverse current per diode at $T_J = 25^{\circ}C$ rated reverse voltage $T_J = 125^{\circ}C$			-		500	μA	
		I _R	-		60	mA	
Typical thermal resistance per diode		R _{eJC}	3			^o C/W	
Operating junction temperature range		TJ	- 55 to +150			°C	
Storage temperature range		T _{STG}	- 55 to +150			°C	
Note 1, 2.0 ve Dules Width f-1.0 kill-		· ·					

Note 1: 2.0 μs Pulse Width, f=1.0 kHz

Note 2: Pulse Test with Pulse Width=300 µs, 1% Duty Cycle



Taiwan Semiconductor

ORDERING INFORMATION PACKING CODE PART NO. PACKING PACKAGE PART NO. PACKING SUFFIX CODE SUFFIX TSF30U60C ITO-220AB C0 G 50 / Tube Μ

EXAMPLE								
PREFERRED P/N	PART NO.	PART NO. PACKING CODE		PACKING CODE	DESCRIPTION			
		SUFFIX		SUFFIX				
TSF30U60CMC0	TSF30U60C	М	CO		Commercial grade			
TSF30U60CMC0G	TSF30U60C	М	C0	G	Commercial grade Green compound			

RATINGS AND CHARACTERISTICS CURVES

(TA=25°C unless otherwise noted)

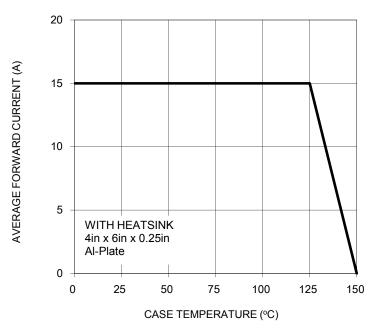


FIG.1 FORWARD CURRENT DERATING CURVE



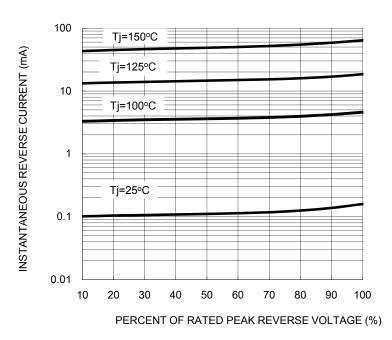


FIG. 2 TYPICAL FORWARD CHARACTERISTICS

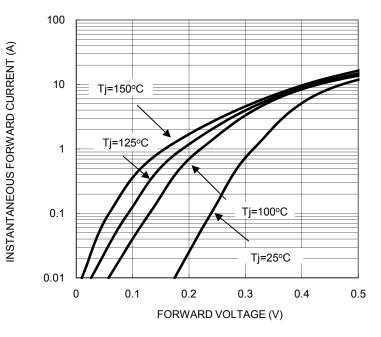
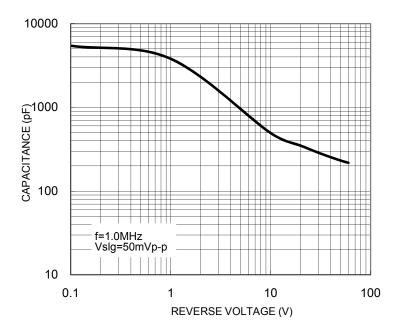


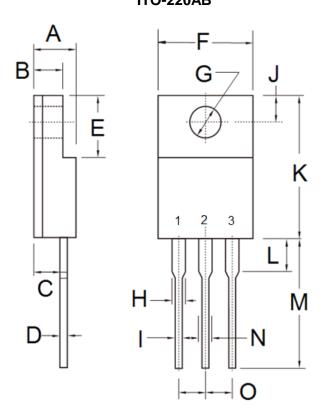
FIG. 4 TYPICAL JUNCTION CAPACITANCE





TSF30U60C Taiwan Semiconductor

PACKAGE OUTLINE DIMENSIONS ITO-220AB



DIM.	Unit	(mm)	Unit (inch)		
	Min	Мах	Min	Мах	
Α	4.30	4.70	0.169	0.185	
В	2.50	3.16	0.098	0.124	
С	2.30	2.96	0.091	0.117	
D	0.46	0.76	0.018	0.030	
E	6.30	6.90	0.248	0.272	
F	9.60	10.30	0.378	0.406	
G	3.00	3.40	0.118	0.134	
Н	0.95	1.45	0.037	0.057	
I	0.50	0.90	0.020	0.035	
J	2.40	3.20	0.094	0.126	
K	14.80	15.50	0.583	0.610	
L	-	4.10	-	0.161	
М	12.60	13.80	0.496	0.543	
Ν	-	1.45	-	0.057	
0	2.41	2.67	0.095	0.105	

MARKING DIAGRAM



- P/N = Specific Device Code
 - = Green Compound
- YWW = Date Code

G

F

= Factory Code



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